



Declaration of Conformity on REACH

Revision: February 2026

On 4 February 2026, two further substances were added to the candidate list of substances of very high concern. The list now comprises 253 entries. In accordance with Articles 7(2) and 33(I) of the REACH Regulation (EC) No 1907/2006, this is intended to increase transparency and safety in the handling of hazardous substances in the EU.

The following Declaration of Conformity applies to all unassembled printed circuit boards produced by the KSG Group. Issues and obligations resulting from regulation (EC) No. 1907/2006 (REACH) and regulation (EG) 2024/2462 (topic 79) have been registered and processed by the KSG Group.

We hereby confirm that we only purchase and process chemicals and semi-finished products from manufacturers/suppliers that are part of our supply chain. We do not produce any substances or mixtures ourselves and only act as product manufacturers in the marketplace. Accordingly, we do not have to register or pre-register any chemicals under REACH.

We hereby also declare that we have requested proof of registration under REACH from all manufacturers/suppliers from whom we purchase chemicals and/or semi-finished products. The registration must also cover use for the production of unassembled printed circuit boards. We do not use substances that are subject to specific prohibitions of use, therefore all KSG Group products are manufactured in compliance with Annexes 14 and 17 of Regulation 1907/2006/EC. In accordance with Article 33, you will be informed if we, as a user of chemicals and precursors, gain new knowledge about hazardous properties of substances or products derived from them that have been placed on the candidate list by the Chemicals Agency ECHA/Helsinki (SVHC substances). The flame retardant Tetrabromobisphenol-A (TBBP-A, CAS 79-94-7) used for most printed circuit boards is one of the substances listed as a substance of very high concern. In the finished printed circuit board, it is no longer present in its original form, but is reactively incorporated into the synthetic resin matrix as part of the polymer. The monomer content of the original TBBP-A is less than 0.1 wt. %. An entry in the SCIP database is therefore not required.

If you have explicitly specified the leaded HAL solder surface finish on the products you have ordered, the circuit boards supplied to you have a content of more than 0.1 % of one of the substances currently on the candidate list (Lead, CAS 7439-92-1). Of course, we have lead-free solder surfaces available in-house as an alternative.

No other "substances of very high concern" are present at levels above 0.1 %. This statement is regularly reviewed and modified as necessary in the course of any amendments to the REACH Regulation and its annexes.

Please do not hesitate to contact us if you have any further questions.

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